

# Product Document

# TCS3400

## Color Light-to-Digital Converter

### General Description

The TCS3400 device provides color and IR (red, green, blue, clear and IR) light sensing. The color sensing provides for improved accuracy lux and color temperature measurements typically used to adjust the backlight intensity and correct the display color gamut. Additionally it can be used for light source type detection as it reports the IR content of the light.

[Ordering Information](#) and [Content Guide](#) appear at end of datasheet.

### Key Benefits & Features

The benefits and features of TCS3400, Color Light-to-Digital Converter are listed below:

**Figure 1:**  
**Added Value of Using TCS3400**

| Benefits                                                                                      | Features                                                                                                                    |
|-----------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------|
| <ul style="list-style-type: none"> <li>Single Device Integrated Optical Solution</li> </ul>   | <ul style="list-style-type: none"> <li>RGBC and ALS Support</li> <li>Power Management Features</li> </ul>                   |
| <ul style="list-style-type: none"> <li>Color Temperature and Ambient Light Sensing</li> </ul> | <ul style="list-style-type: none"> <li>Programmable Gain &amp; Integration Time</li> <li>1000000:1 Dynamic Range</li> </ul> |
| <ul style="list-style-type: none"> <li>Equal Response to 360 degree Incident Light</li> </ul> | <ul style="list-style-type: none"> <li>Circular Segmented RGBC Photodiode</li> </ul>                                        |
| <ul style="list-style-type: none"> <li>Ideal for Operation Behind Dark Glass</li> </ul>       | <ul style="list-style-type: none"> <li>Very High Sensitivity</li> </ul>                                                     |
| <ul style="list-style-type: none"> <li>Light Source Detection</li> </ul>                      | <ul style="list-style-type: none"> <li>RGBC + IR sensor</li> </ul>                                                          |

### Applications

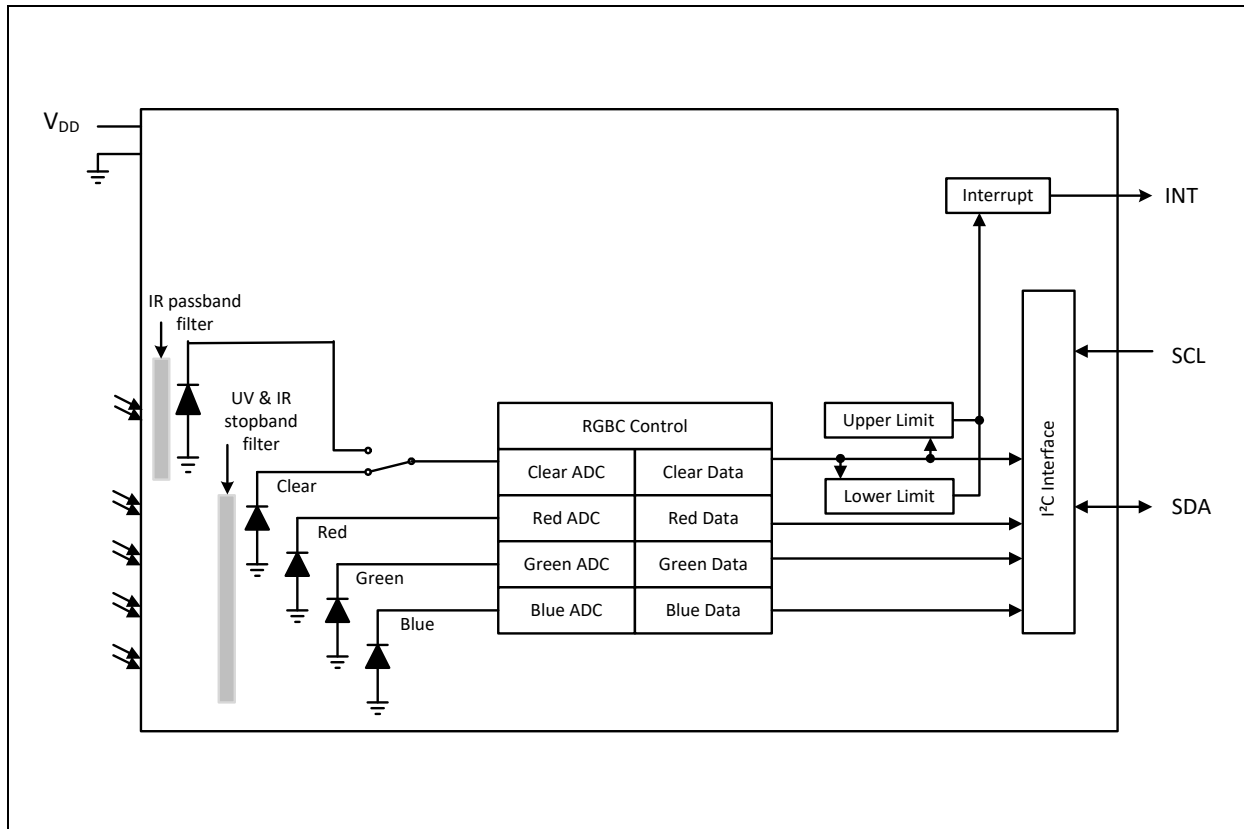
The TCS3400 applications include:

- Ambient light sensing
- Color temperature sensing
- Industrial process control
- Medical diagnostics

## Block Diagram

The functional blocks of this device are shown below:

**Figure 2:**  
**TCS3400 Block Diagram**



Pin Assignment

The TCS3400 pin assignments are described below.

Figure 3:  
Pin Diagram

**Pin Diagram (Top View):**  
Package FN Dual Flat No-Lead.  
Package Drawing is not to scale.

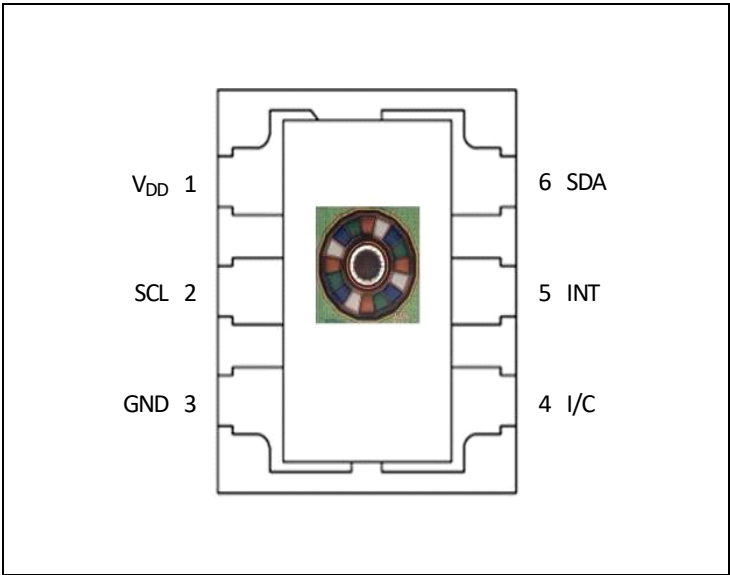


Figure 4:  
Pin Description

| Pin Number | Pin Name        | Description                                               |
|------------|-----------------|-----------------------------------------------------------|
| 1          | V <sub>DD</sub> | Supply voltage                                            |
| 2          | SCL             | I <sup>2</sup> C serial clock input terminal              |
| 3          | GND             | Power supply ground. All voltages are referenced to GND.  |
| 4          | I/C             | Internal connection, connect to ground or leave floating. |
| 5          | INT             | Interrupt — open drain output (active low)                |
| 6          | SDA             | I <sup>2</sup> C serial data I/O terminal – open drain    |

## Absolute Maximum Ratings

Stresses beyond those listed under [Absolute Maximum Ratings](#) may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under [Recommended Operating Conditions](#) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**Figure 5:**  
**Absolute Maximum Ratings**

| Parameter                                                   | Min        | Max | Units | Comments                             |
|-------------------------------------------------------------|------------|-----|-------|--------------------------------------|
| Supply voltage, $V_{DD}$                                    |            | 3.8 | V     | All voltages are with respect to GND |
| Input terminal voltage                                      | -0.5       | 3.8 | V     |                                      |
| Output terminal voltage                                     | -0.5       | 3.8 | V     |                                      |
| Output terminal current (SDA, INT)                          | -1         | 20  | mA    |                                      |
| Storage temperature range, $T_{STRG}$                       | -40        | 85  | °C    |                                      |
| Input current (latch up immunity)<br>JEDEC JESD78D Nov 2011 | CLASS 1    |     |       |                                      |
| Electrostatic discharge HBM S-001-2014                      | $\pm 2000$ |     | V     |                                      |
| Electrostatic discharge CDM<br>JEDEC JESD22-C101F Oct 2013  | $\pm 500$  |     | V     |                                      |

## Electrical Characteristics

All limits are guaranteed. The parameters with min and max values are guaranteed with production tests or SQC (Statistical Quality Control) methods.

**Figure 6:**  
Recommended Operating Conditions

| Symbol   | Parameter                                     | Min | Typ | Max | Units |
|----------|-----------------------------------------------|-----|-----|-----|-------|
| $V_{DD}$ | Supply voltage                                | 2.7 | 3   | 3.6 | V     |
| $T_A$    | Operating free-air temperature <sup>(1)</sup> | -40 |     | 70  | °C    |

**Note(s):**

1. While the device is operational across the temperature range, functionality will vary with temperature. Specifications are stated at 25°C unless otherwise noted.

**Figure 7:**  
Operating Characteristics,  $V_{DD}=3V$ ,  $T_A=25^\circ C$  (unless otherwise noted)

| Symbol     | Parameter                           | Conditions                                 | Min          | Typ | Max          | Units   |
|------------|-------------------------------------|--------------------------------------------|--------------|-----|--------------|---------|
| $I_{DD}$   | Supply current                      | Active                                     |              | 235 | 330          | $\mu A$ |
|            |                                     | Wait state                                 |              | 60  |              |         |
|            |                                     | Sleep state - no I <sup>2</sup> C activity |              | 1.0 | 10           |         |
| $V_{OL}$   | INT, SDA output low voltage         | 3 mA sink current                          | 0            |     | 0.4          | V       |
|            |                                     | 6 mA sink current                          | 0            |     | 0.6          |         |
| $I_{LEAK}$ | Leakage current, SDA, SCL, INT pins |                                            | -5           |     | 5            | $\mu A$ |
| $V_{IH}$   | SCL, SDA input high voltage         | TCS34001, TCS34005                         | $0.7 V_{DD}$ |     |              | V       |
|            |                                     | TCS34003, TCS34007                         | 1.26         |     |              |         |
| $V_{IL}$   | SCL, SDA input low voltage          | TCS34001, TCS34005                         |              |     | $0.3 V_{DD}$ | V       |
|            |                                     | TCS34003, TCS34007                         |              |     | 0.54         |         |

Figure 8:

Optical Characteristics (Clear Channel),  $V_{DD} = 3V$ ,  $T_A = 25^\circ C$ ,  $AGAIN = 16x$ ,  $ATIME = 0xF6$  (27.8ms)

| Parameter                                           | Test Conditions                                | Min  | Typ  | Max  | Unit                        |
|-----------------------------------------------------|------------------------------------------------|------|------|------|-----------------------------|
| $R_e$<br>Irradiance Responsivity<br>(Clear Channel) | White LED, CCT = 2700K <sup>(1)</sup>          | 11.2 | 14.0 | 16.8 | counts/<br>( $\mu W/cm^2$ ) |
|                                                     | Blue LED, $\lambda_D = 465$ nm <sup>(2)</sup>  | 9.5  | 11.8 | 14.2 |                             |
|                                                     | Green LED, $\lambda_D = 525$ nm <sup>(3)</sup> | 11.6 | 14.5 | 17.4 |                             |
|                                                     | Red LED, $\lambda_D = 615$ nm <sup>(4)</sup>   | 13.6 | 17.0 | 20.4 |                             |

**Note(s):**

1. The white LED irradiance is supplied by a warm white light-emitting diode with a nominal color temperature of 2700K.
2. The 465 nm input irradiance is supplied by an InGaN light-emitting diode with the following typical characteristics: dominant wavelength  $\lambda_D = 465$  nm, spectral halfwidth  $\Delta\lambda_{1/2} = 22$  nm.
3. The 525 nm input irradiance is supplied by an InGaP light-emitting diode with the following typical characteristics: dominant wavelength  $\lambda_D = 525$  nm, spectral halfwidth  $\Delta\lambda_{1/2} = 35$  nm.
4. The 615 nm input irradiance is supplied by an AlInGaP light-emitting diode with the following typical characteristics: dominant wavelength  $\lambda_D = 615$  nm, spectral halfwidth  $\Delta\lambda_{1/2} = 15$  nm.

Figure 9:

Optical Characteristics (IR Channel),  $V_{DD} = 3V$ ,  $T_A = 25^\circ C$ ,  $AGAIN = 16x$ ,  $ATIME = 0xF6$  (27.8ms)

| Parameter                                        | Test Condition                      | Min  | Typ  | Max  | Unit                        |
|--------------------------------------------------|-------------------------------------|------|------|------|-----------------------------|
| $R_e$<br>Irradiance Responsivity<br>(IR Channel) | $\lambda_p = 850$ nm <sup>(1)</sup> | 10.0 | 13.3 | 16.6 | counts/<br>( $\mu W/cm^2$ ) |

**Note(s):**

1. The 850 nm input irradiance is supplied by an AlGaAs light-emitting diode with the following characteristics: peak wavelength  $\lambda_p = 850$  nm, spectral halfwidth  $\Delta\lambda_{1/2} = 42$  nm.

**Figure 10:**  
**Optical Characteristics,  $V_{DD}=3V$ ,  $T_A=25^\circ C$**

| Parameter                                  | Test Conditions                             | Red / Clear Channel |      | Green / Clear Channel |     | Blue / Clear Channel |     | IR / Clear Channel |     |
|--------------------------------------------|---------------------------------------------|---------------------|------|-----------------------|-----|----------------------|-----|--------------------|-----|
|                                            |                                             | Min                 | Max  | Min                   | Max | Min                  | Max | Min                | Max |
| Color ADC count value ratio: Color / Clear | $\lambda_D = 465 \text{ nm}$ <sup>(1)</sup> | 0%                  | 13%  | 10%                   | 38% | 70%                  | 91% |                    |     |
|                                            | $\lambda_D = 525 \text{ nm}$ <sup>(2)</sup> | 3%                  | 22%  | 59%                   | 86% | 10%                  | 40% |                    |     |
|                                            | $\lambda_D = 615 \text{ nm}$ <sup>(3)</sup> | 80%                 | 110% | 0%                    | 15% | 3%                   | 26% | 0%                 | 5%  |
|                                            | $\lambda_P = 850 \text{ nm}$ <sup>(4)</sup> |                     |      |                       |     |                      |     | 667%               |     |

**Note(s):**

1. The 465 nm input irradiance is supplied by an InGaN light-emitting diode with the following characteristics: dominant wavelength  $\lambda_D = 465 \text{ nm}$ , spectral halfwidth  $\Delta\lambda_{1/2} = 22 \text{ nm}$ .
2. The 525 nm input irradiance is supplied by an InGaN light-emitting diode with the following characteristics: dominant wavelength  $\lambda_D = 525 \text{ nm}$ , spectral halfwidth  $\Delta\lambda_{1/2} = 35 \text{ nm}$ .
3. The 615 nm input irradiance is supplied by a AlInGaP light-emitting diode with the following characteristics: dominant wavelength  $\lambda_D = 615 \text{ nm}$ , spectral halfwidth  $\Delta\lambda_{1/2} = 15 \text{ nm}$ .
4. The 850 nm input irradiance is supplied by an AlGaAs light-emitting diode with the following characteristics: peak wavelength  $\lambda_P = 850 \text{ nm}$ , spectral halfwidth  $\Delta\lambda_{1/2} = 42 \text{ nm}$ .

**Figure 11:**  
**RGBC Characteristics,  $V_{DD} = 3V$ ,  $T_A = 25^\circ C$ , AGAIN = 16x, AEN = 1 (unless otherwise noted)**

| Parameter                                        | Conditions                                                | Min   | Typ   | Max   | Units                 |
|--------------------------------------------------|-----------------------------------------------------------|-------|-------|-------|-----------------------|
| Dark ADC count value<br>(Clear and RGB Channels) | E <sub>e</sub> = 0, AGAIN = 64x,<br>ATIME = 0xB8 (200ms)  | 0     | 1     | 4     | counts                |
|                                                  |                                                           | 0     |       | 2     | counts <sup>(1)</sup> |
| Dark ADC count value<br>(IR Channel)             |                                                           | 0     | 1     | 6     | counts                |
|                                                  |                                                           | 0     |       | 4     | counts <sup>(1)</sup> |
| Integration time step size                       |                                                           | 2.65  | 2.78  | 2.93  | ms                    |
| Number of integration steps                      |                                                           | 1     |       | 256   | steps                 |
| ADC count value                                  | ATIME = 0xFF (2.78ms) to 0xC1<br>(175ms) (1 to 63 steps)  | 0     |       | 1024  | counts/<br>step       |
|                                                  | ATIME = 0xC0 (178ms) to 0x00<br>(712ms) (64 to 256 steps) | 0     |       | 65535 | counts                |
| Gain scaling, relative to 16x<br>gain setting    | 1x: AGAIN = 00                                            | 0.936 | 0.985 | 1.065 | ×                     |
|                                                  | 4x: AGAIN = 01                                            | 3.66  | 3.85  | 4.16  |                       |
|                                                  | 16x: AGAIN = 10                                           |       | 16.0  |       |                       |
|                                                  | 64x: AGAIN = 11                                           | 59.6  | 62.7  | 67.8  |                       |

**Note(s):**

1. Based on typical 3-sigma distribution. Not 100% tested.

**Figure 12:**  
**Wait Characteristics,  $V_{DD} = 3V$ ,  $T_A = 25^\circ C$ , WEN = 1 (unless otherwise noted)**

| Parameter      | Conditions   | Min | Typ  | Max | Units |
|----------------|--------------|-----|------|-----|-------|
| Wait step size | WTIME = 0xFF |     | 2.78 |     | ms    |

## Timing Characteristics

The timing characteristics of TCS3400 are given below.

**Figure 13:**  
AC Electrical Characteristics,  $V_{DD} = 3V$ ,  $T_A = 25^\circ C$  (unless otherwise noted)

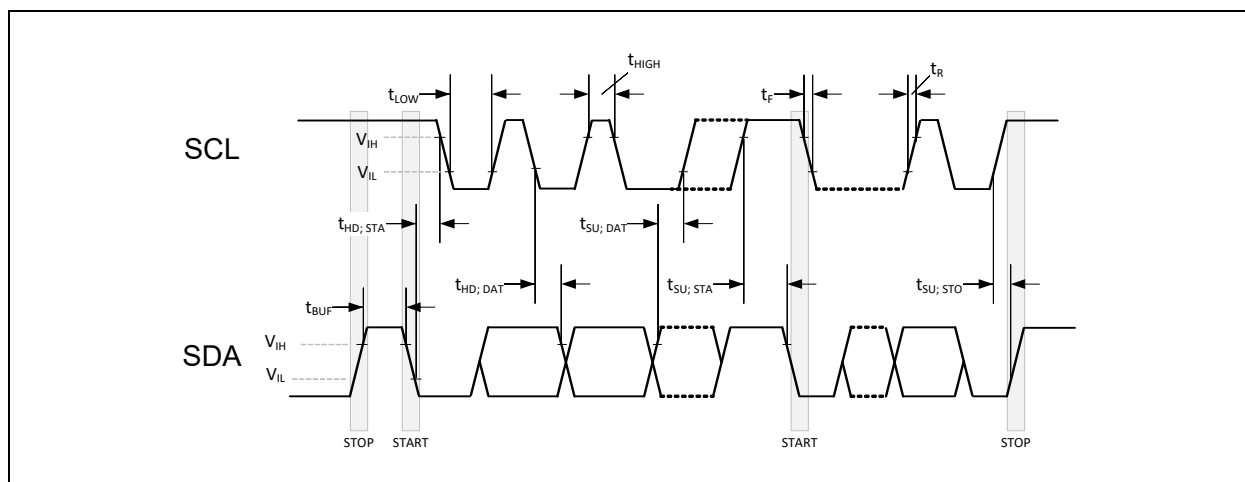
| Parameter <sup>(1)</sup> | Conditions                                                                                   | Min | Max | Unit    |
|--------------------------|----------------------------------------------------------------------------------------------|-----|-----|---------|
| $f_{SCL}$                | Clock frequency (I <sup>2</sup> C only)                                                      | 0   | 400 | kHz     |
| $t_{BUF}$                | Bus free time between start and stop condition                                               | 1.3 |     | $\mu s$ |
| $t_{HD;STA}$             | Hold time after (repeated) start condition. After this period, the first clock is generated. | 0.6 |     | $\mu s$ |
| $t_{SU;STA}$             | Repeated start condition setup time                                                          | 0.6 |     | $\mu s$ |
| $t_{SU;STO}$             | Stop condition setup time                                                                    | 0.6 |     | $\mu s$ |
| $t_{HD;DAT}$             | Data hold time                                                                               | 60  |     | ns      |
| $t_{SU;DAT}$             | Data setup time                                                                              | 100 |     | ns      |
| $t_{LOW}$                | SCL clock low period                                                                         | 1.3 |     | $\mu s$ |
| $t_{HIGH}$               | SCL clock high period                                                                        | 0.6 |     | $\mu s$ |
| $t_F$                    | Clock/data fall time                                                                         |     | 300 | ns      |
| $t_R$                    | Clock/data rise time                                                                         |     | 300 | ns      |
| $C_i$                    | Input pin capacitance                                                                        |     | 10  | pF      |

**Note(s):**

1. Specified by design and characterization; not production tested.

## Timing Diagram

**Figure 14:**  
Parameter Measurement Information



## Typical Operating Characteristics

Figure 15:  
Spectral Responsivity

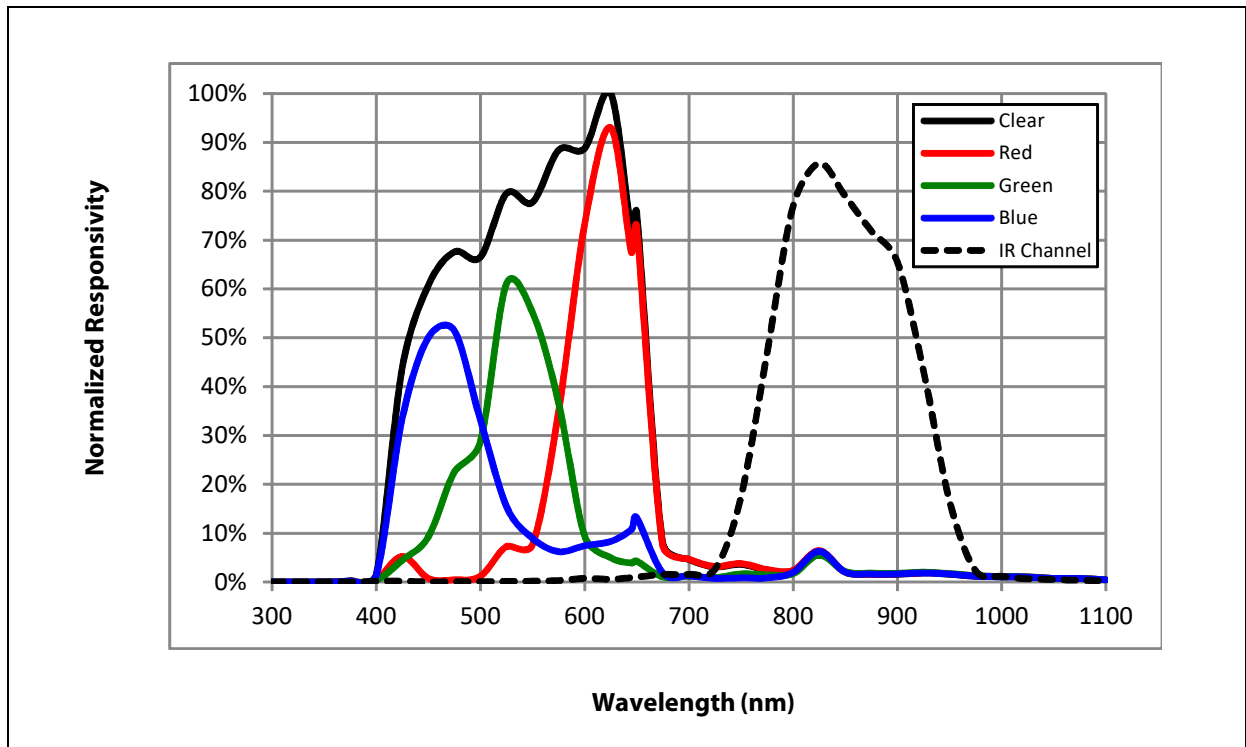


Figure 16:  
Normalized Responsivity vs. Angular Displacement

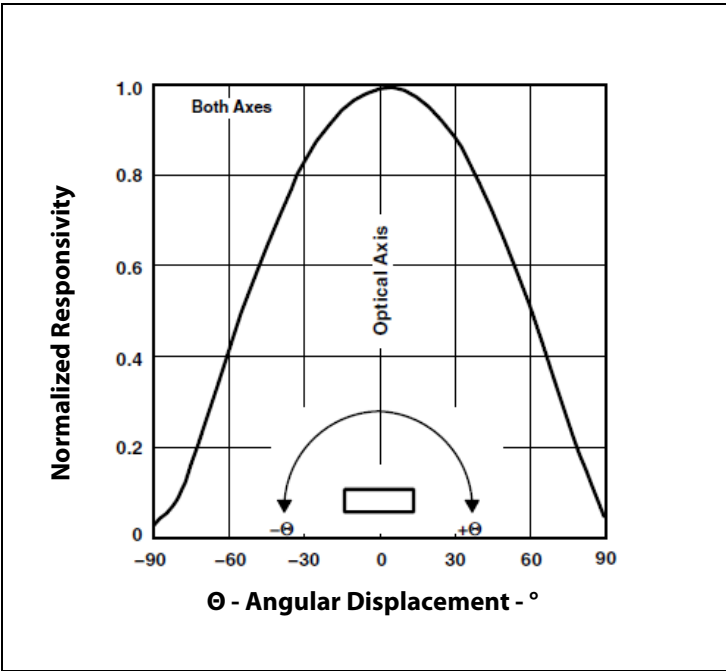


Figure 17:  
Responsivity Temperature Coefficient

| Wavelength  | Temperature Coefficient |
|-------------|-------------------------|
| 400 – 670nm | 250 ppm/°C              |
| 850nm       | 2500 ppm/°C             |
| 950nm       | 5500 ppm/°C             |

## Functional Description

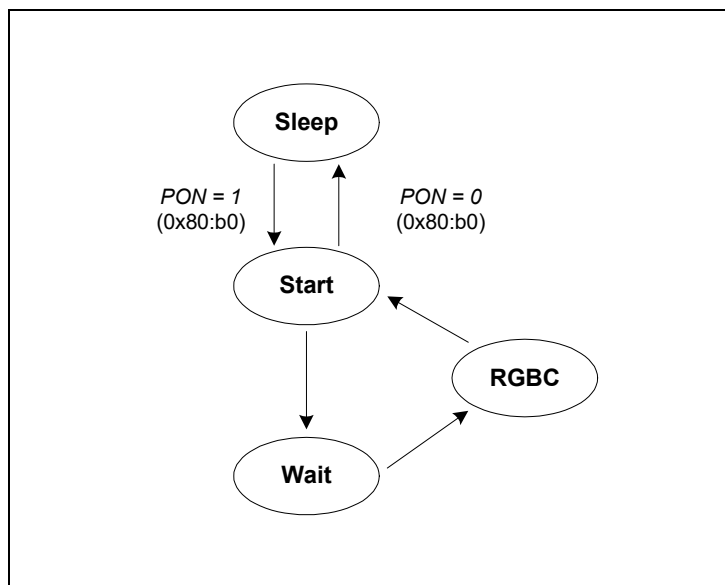
The TCS3400 device provides ambient light sensing and color temperature sensing. The internal state machine manages the operation of the device. It controls the ALS functionality and power down modes. Average power consumption is managed via control of variable endurance low power wait cycles.

The interrupt feature improves system efficiency by eliminating the need to poll the sensor. Two interrupt sources (ALS, ALS saturation) can activate the open drain output pin. Each interrupt source is enabled independently. ALS interrupts appear when upper or lower thresholds are exceeded for a consecutive number of sample readings.

The advanced digital color light sensor portion of the TCS3400 contains a segmented circular photodiode array used for color measurements. This architecture provides stable color sensing independent of the incident angle of light. Four integrating analog-to-digital converters (ADCs) integrate light energy from photodiodes simultaneously.

**Figure 18:**  
**Simplified ALS State Machine**

Communication with the device is accomplished through a fast (up to 400 kHz) two wire I<sup>2</sup>C serial bus for easy connection to a microcontroller or embedded controller. The device typically draws only 235µA in color operation and 1µA during power down.



## Register Description

The device is controlled and monitored by registers accessed through the I<sup>2</sup>C serial interface. These registers provide for a variety of control functions and can be read to determine results of the ADC conversions. The register set is summarized in the figure below.

**Figure 19:**  
**Register Map**

| Address | Register Name | R/W | Register Function                        | Reset Value |
|---------|---------------|-----|------------------------------------------|-------------|
| 0x80    | ENABLE        | R/W | Enables states and interrupts            | 0x00        |
| 0x81    | ATIME         | R/W | RGBC integration time                    | 0xFF        |
| 0x83    | WTIME         | R/W | Wait time                                | 0xFF        |
| 0x84    | AILTL         | R/W | Clear interrupt low threshold low byte   | 0x00        |
| 0x85    | AILTH         | R/W | Clear interrupt low threshold high byte  | 0x00        |
| 0x86    | AIHTL         | R/W | Clear interrupt high threshold low byte  | 0x00        |
| 0x87    | AIHTH         | R/W | Clear interrupt high threshold high byte | 0x00        |
| 0x8C    | PERS          | R/W | Interrupt persistence filter             | 0x00        |
| 0x8D    | CONFIG        | R/W | Configuration                            | 0x40        |
| 0x8F    | CONTROL       | R/W | Gain control register                    | 0x00        |
| 0x90    | AUX           | R/W | Auxiliary control register               | 0x00        |
| 0x91    | REVID         | R   | Revision ID                              | Rev         |
| 0x92    | ID            | R   | Device ID                                | ID          |
| 0x93    | STATUS        | R   | Device status                            | 0x00        |
| 0x94    | CDATAL        | R   | Clear / IR channel low data register     | 0x00        |
| 0x95    | CDATAH        | R   | Clear / IR channel high data register    | 0x00        |
| 0x96    | RDATAH        | R   | Red ADC low data register                | 0x00        |
| 0x97    | RDATAH        | R   | Red ADC high data register               | 0x00        |
| 0x98    | GDATAH        | R   | Green ADC low data register              | 0x00        |
| 0x99    | GDATAH        | R   | Green ADC high data register             | 0x00        |

| Address | Register Name | R/W | Register Function             | Reset Value |
|---------|---------------|-----|-------------------------------|-------------|
| 0x9A    | BDATAL        | R   | Blue ADC low data register    | 0x00        |
| 0x9B    | BDATAH        | R   | Blue ADC high data register   | 0x00        |
| 0xC0    | IR            | R/W | Access IR Channel             | 0x00        |
| 0xE4    | IFORCE        | W   | Force Interrupt               | 0x00        |
| 0xE6    | CICLEAR       | W   | Clear channel interrupt clear | 0x00        |
| 0xE7    | AICLEAR       | W   | Clear all interrupts          | 0x00        |

### Enable Register (ENABLE 0 x 80)

The Enable Register is used primarily to power the device ON/OFF, and enable functions and interrupts.

**Figure 20:**  
Enable Register

|          |     |          |      |     |          |     |     |
|----------|-----|----------|------|-----|----------|-----|-----|
| 7        | 6   | 5        | 4    | 3   | 2        | 1   | 0   |
| Reserved | SAI | Reserved | AIEN | WEN | Reserved | AEN | PON |

| Field    | Bits | Description                                                                                                                                                                                                                                                                                                                                                                                            |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Reserved | 7    | <b>Reserved.</b> Write as 0.                                                                                                                                                                                                                                                                                                                                                                           |
| SAI      | 6    | <b>Sleep After Interrupt.</b> When asserted, the device will power down at the end of a RGBC cycle if an interrupt is generated.                                                                                                                                                                                                                                                                       |
| Reserved | 5    | <b>Reserved.</b> Write as 0.                                                                                                                                                                                                                                                                                                                                                                           |
| AIEN     | 4    | <b>ALS Interrupt Enable.</b> When asserted permits ALS interrupts to be generated, subject to the persist filter.                                                                                                                                                                                                                                                                                      |
| WEN      | 3    | <b>Wait Enable.</b> This bit activates the wait feature. Writing a 1 activates the wait timer. Writing a 0 disables the wait timer.                                                                                                                                                                                                                                                                    |
| Reserved | 2    | <b>Reserved.</b> Write as 0.                                                                                                                                                                                                                                                                                                                                                                           |
| AEN      | 1    | <b>ADC Enable.</b> This bit activates the four-channel (RGBC) ADC. Writing a 1 enables the ADC. Writing a 0 disables the ADC.                                                                                                                                                                                                                                                                          |
| PON      | 0    | <b>Power ON.</b> This bit activates the internal oscillator to permit the timers and ADC channels to operate. Writing a 1 activates the oscillator. Writing a 0 disables the oscillator and puts the part into a low power sleep mode. During reads and writes over the I <sup>2</sup> C interface, this bit is temporarily overridden and the oscillator is enabled, independent of the state of PON. |

### RGBC Integration Time Register (ATIME 0x81)

The ATIME register controls the internal integration time of the RGBC channel ADCs. Upon power up, the RGBC time register is set to 0xFF.

The maximum (or saturation) count value can be calculated based upon the integration time cycles as follows:

$$\min [CYCLES * 1024, 65535]$$

**Figure 21:**  
RGBC Integration Time Register

| Field | Bits | Description |        |         |           |
|-------|------|-------------|--------|---------|-----------|
|       |      | Value       | Cycles | Time    | Max Count |
| ATIME | 7:0  | 0xFF        | 1      | 2.78 ms | 1024      |
|       |      | 0xF6        | 10     | 27.8 ms | 10240     |
|       |      | 0xDB        | 37     | 103 ms  | 37888     |
|       |      | 0xC0        | 64     | 178 ms  | 65535     |
|       |      | 0x00        | 256    | 712 ms  | 65535     |

### Wait Time Register (WTIME 0x83)

The WTIME controls the amount of time in a low power mode. It is set 2.78 ms increments unless the WLONG bit is asserted in which case the wait times are 12x longer. WTIME is programmed as a 2's complement number. Upon power up, the wait time register is set to 0xFF.

**Figure 22:**  
Wait Time Register

| Field | Bits | Description    |           |                |                |
|-------|------|----------------|-----------|----------------|----------------|
|       |      | Register Value | Wait Time | Time (WLONG=0) | Time (WLONG=1) |
| WTIME | 7:0  | 0xFF           | 1         | 2.78 ms        | 0.03 s         |
|       |      | 0xAB           | 85        | 236 ms         | 2.84 s         |
|       |      | 0x00           | 256       | 712 ms         | 8.54 s         |

**Note(s):**

1. The wait time register should be configured before AEN is asserted.

## Clear Channel Interrupt Threshold Register (0x84 - 0x87)

The Clear Channel Interrupt Threshold Registers provide 16 bit values to be used as the high and low thresholds for comparison to the 16 bit CDATE values. If AIEN (0x80:b4) is enabled and CDATE is not between AILT and AIHT for the number of consecutive samples specified in APERS (0x8C:b[3:0]) an interrupt is asserted on the interrupt pin.

**Figure 23:**  
Clear Channel Interrupt Threshold Registers

| Register | Address | Bits | Description                             |
|----------|---------|------|-----------------------------------------|
| AILTL    | 0x84    | 7:0  | Clear Channel low threshold lower byte  |
| AILTH    | 0x85    | 7:0  | Clear Channel low threshold upper byte  |
| AIHTL    | 0x86    | 7:0  | Clear Channel high threshold lower byte |
| AIHTH    | 0x87    | 7:0  | Clear Channel high threshold upper byte |

## Interrupt Register (0x8C)

The Interrupt Register controls the interrupt capabilities of the device.

**Figure 24:**  
Interrupt Register

|          |   |   |   |       |   |   |   |
|----------|---|---|---|-------|---|---|---|
| 7        | 6 | 5 | 4 | 3     | 2 | 1 | 0 |
| Reserved |   |   |   | APERS |   |   |   |

| Field    | Bits | Description                                                                                         |                                         |
|----------|------|-----------------------------------------------------------------------------------------------------|-----------------------------------------|
| Reserved | 7:4  | <b>Reserved.</b> Write as 0.                                                                        |                                         |
| APERS    | 3:0  | <b>Clear Interrupt Persistence.</b> Controls rate of Clear channel interrupt to the host processor. |                                         |
|          |      | Field Value                                                                                         | Persistence                             |
|          |      | 0000                                                                                                | Every RGBC cycle generates an interrupt |
|          |      | 0001                                                                                                | Any value outside of threshold range    |
|          |      | 0010                                                                                                | 2 consecutive values out of range       |
|          |      | 0011                                                                                                | 3 consecutive values out of range       |
|          |      | 0100                                                                                                | 5 consecutive values out of range       |
|          |      | 0101                                                                                                | 10 consecutive values out of range      |
|          |      | 0110                                                                                                | 15 consecutive values out of range      |
|          |      | 0111                                                                                                | 20 consecutive values out of range      |
|          |      | 1000                                                                                                | 25 consecutive values out of range      |
|          |      | 1001                                                                                                | 30 consecutive values out of range      |
|          |      | 1010                                                                                                | 35 consecutive values out of range      |
|          |      | 1011                                                                                                | 40 consecutive values out of range      |
|          |      | 1100                                                                                                | 45 consecutive values out of range      |
|          |      | 1101                                                                                                | 50 consecutive values out of range      |
|          |      | 1110                                                                                                | 55 consecutive values out of range      |
|          |      | 1111                                                                                                | 60 consecutive values out of range      |

### Configuration Register (CONFIG 0x8D)

The CONFIG register sets the wait long time. The registers is set 0x40 at power up.

**Figure 25:**  
Configuration Register

|          |           |          |   |   |   |       |          |
|----------|-----------|----------|---|---|---|-------|----------|
| 7        | 6         | 5        | 4 | 3 | 2 | 1     | 0        |
| Reserved | Reserved1 | Reserved |   |   |   | WLONG | Reserved |

| Field                   | Bits | Description                                                                                                                |
|-------------------------|------|----------------------------------------------------------------------------------------------------------------------------|
| Reserved                | 7    | <b>Reserved.</b> Write as 0.                                                                                               |
| Reserved <sup>(1)</sup> | 6    | <b>Reserved.</b> Write as 1.                                                                                               |
| Reserved                | 5:2  | <b>Reserved.</b> Write all as 0.                                                                                           |
| WLONG                   | 1    | <b>Wait Long.</b> When asserted, the wait cycles are increased by a factor 12x from that programmed in the WTIME register. |
| Reserved                | 0    | <b>Reserved.</b> Write as 0.                                                                                               |

**Note(s):**

1. Bit 6 is reserved and has to be programmed = 1.

### Control Register (CONTROL 0x8F)

**Figure 26:**  
Control Register

|          |   |   |   |   |   |       |   |
|----------|---|---|---|---|---|-------|---|
| 7        | 6 | 5 | 4 | 3 | 2 | 1     | 0 |
| Reserved |   |   |   |   |   | AGAIN |   |

| Field    | Bits | Description               |                 |
|----------|------|---------------------------|-----------------|
| Reserved | 7:2  | Reserved. Write all as 0. |                 |
| AGAIN    | 1:0  | RGBC Gain Control.        |                 |
|          |      | FIELD VALUE               | RGBC GAIN VALUE |
|          |      | 00                        | 1x Gain         |
|          |      | 01                        | 4x Gain         |
|          |      | 10                        | 16x Gain        |
|          |      | 11                        | 64x Gain        |

### Auxiliary Register (AUX 0x90)

The AUX register enables the ALS saturation detection interrupt. If ASIEN = 1 and an interrupt occurs it is cleared by accessing the Clear Interrupt registers at 0xE6 or 0xE7.

**Figure 27:**  
Auxiliary Register

|          |   |       |          |   |   |   |   |
|----------|---|-------|----------|---|---|---|---|
| 7        | 6 | 5     | 4        | 3 | 2 | 1 | 0 |
| Reserved |   | ASIEN | Reserved |   |   |   |   |

| Field    | Bits | Description                                    |
|----------|------|------------------------------------------------|
| Reserved | 7:6  | <b>Reserved.</b> Write all as 0.               |
| ASIEN    | 5    | 0 disables, 1 enables ALS Saturation Interrupt |
| Reserved | 4:0  | <b>Reserved.</b>                               |

### Revision ID Register (REVID 0x91)

This read-only register identifies the die revision level.

**Figure 28:**  
Revision ID Register

|          |   |   |   |       |   |   |   |
|----------|---|---|---|-------|---|---|---|
| 7        | 6 | 5 | 4 | 3     | 2 | 1 | 0 |
| Reserved |   |   |   | RevID |   |   |   |

| Field    | Bits | Description              |
|----------|------|--------------------------|
| Reserved | 7:4  | <b>Reserved.</b>         |
| RevID    | 3:0  | Wafer die revision level |

## ID Register (ID 0x92)

The read-only ID register provides the device identification.

**Figure 29:**  
ID Register

|    |   |   |   |   |   |     |   |
|----|---|---|---|---|---|-----|---|
| 7  | 6 | 5 | 4 | 3 | 2 | 1   | 0 |
| ID |   |   |   |   |   | VID |   |

| Field | Bits | Description                                                |
|-------|------|------------------------------------------------------------|
| ID    | 7:2  | Device Identification = 100100                             |
| VID   | 1:0  | 00b for TCS34001 & TCS34005<br>11b for TCS34003 & TCS34007 |

## Status Register (STATUS 0x93)

The read-only Status Register provides the internal status of the device.

**Figure 30:**  
Status Register

|      |          |   |      |          |   |        |   |
|------|----------|---|------|----------|---|--------|---|
| 7    | 6        | 5 | 4    | 3        | 2 | 1      | 0 |
| ASAT | Reserved |   | AINT | Reserved |   | AVALID |   |

| Field    | Bits | Description                                                                                                                                                                                                                                                                                                                                                             |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ASAT     | 7    | <b>ALS Saturation.</b> When asserted, the analog sensor was at the upper end of its dynamic range. The bit can be de-asserted by sending a clear channel interrupt command (0xE6 CICLEAR) or by disabling the ALS ADC (AEN=0). ATIME and AGAIN are controls that can be adjusted to set when saturation happens. This bit triggers an interrupt if ASIEN in AUX is set. |
| Reserved | 6:5  | <b>Reserved.</b>                                                                                                                                                                                                                                                                                                                                                        |
| AINT     | 4    | <b>ALS Interrupt.</b> If AEN is set, indicates that an ALS event that met the programmed ALS thresholds (AILT or AIHT) and persistence (APERS) occurred.                                                                                                                                                                                                                |
| Reserved | 3:1  | <b>Reserved.</b>                                                                                                                                                                                                                                                                                                                                                        |
| AVALID   | 0    | <b>RGBC Valid.</b> Indicates that the RGBC cycle has completed since AEN was asserted.                                                                                                                                                                                                                                                                                  |

### RGBC Data Registers (0x94 - 0x9B)

Clear, red, green, and blue data is stored as 16-bit values. The read sequence must read byte pairs (low followed by high) starting on an even address boundary (0x94, 0x96, 0x98, or 0x9A) inside the RGBC Data Register block. When the lower byte register is read, the upper eight bits are stored into a shadow register, which is read by a subsequent read to the upper byte. The upper register will read the correct value even if additional ADC integration cycles end between the reading of the lower and upper registers.

**Figure 31:**  
**RGBC Data Registers**

| Register | Address | Bits | Description               |
|----------|---------|------|---------------------------|
| CDATAL   | 0x94    | 7:0  | Clear / IR data low byte  |
| CDATAH   | 0x95    | 7:0  | Clear / IR data high byte |
| RDATAH   | 0x96    | 7:0  | Red data low byte         |
| RDATAH   | 0x97    | 7:0  | Red data high byte        |
| GDATAH   | 0x98    | 7:0  | Green data low byte       |
| GDATAH   | 0x99    | 7:0  | Green data high byte      |
| BDATAH   | 0x9A    | 7:0  | Blue data low byte        |
| BDATAH   | 0x9B    | 7:0  | Blue data high byte       |

## IR Register (0xC0)

Access to IR channel; allows mapping of IR channel on clear channel.

**Figure 32:**  
IR Register

|    |          |   |   |   |   |   |   |
|----|----------|---|---|---|---|---|---|
| 7  | 6        | 5 | 4 | 3 | 2 | 1 | 0 |
| IR | Reserved |   |   |   |   |   |   |

| Field    | Bits | Description                                                                                                              |
|----------|------|--------------------------------------------------------------------------------------------------------------------------|
| IR       | 7    | <b>IR Sensor access.</b> If this bit is set the clear channel reports the measurement from the IR sensor (center diode). |
| Reserved | 6:0  | <b>Reserved.</b> Always write as 0.                                                                                      |

## Clear Interrupt Registers (0xE3, 0xE7)

Any dummy data byte (0x00 recommended) written to the specified register will clear the indicated interrupt.

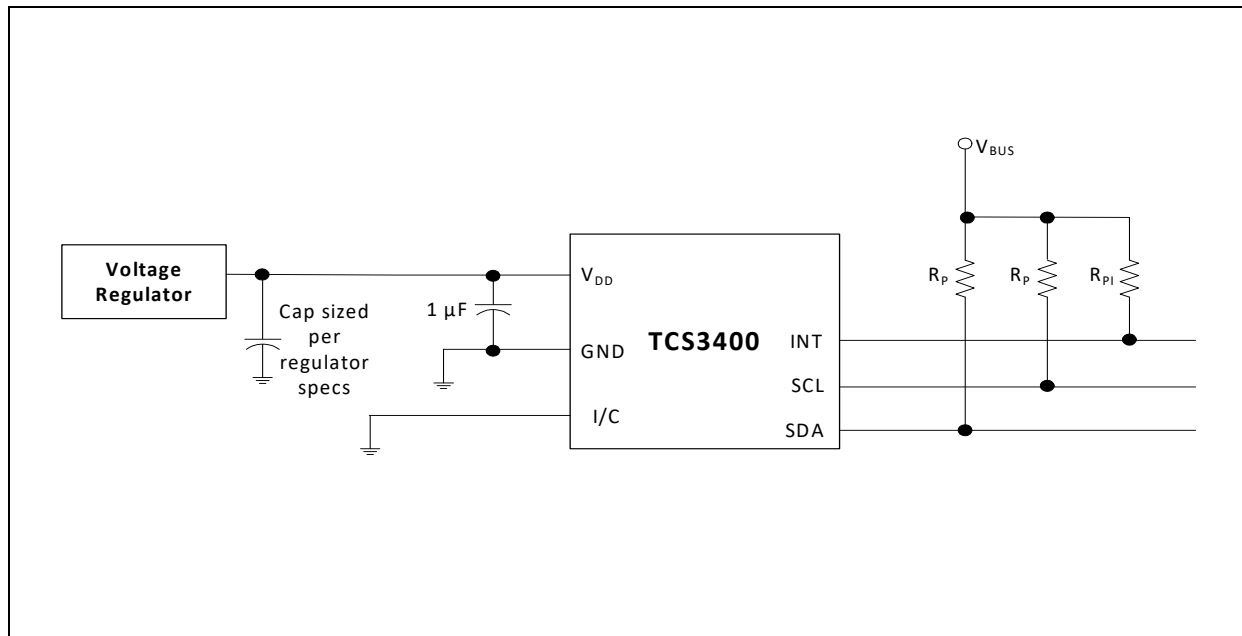
**Figure 33:**  
Clear Interrupt Registers

| Register | Address | Bits | Description                               |
|----------|---------|------|-------------------------------------------|
| IFORCE   | 0xE4    | 7:0  | Forces an interrupt (any value)           |
| CICLEAR  | 0xE6    | 7:0  | Clear channel interrupt clear (any value) |
| AICLEAR  | 0xE7    | 7:0  | Clears all interrupts (any value)         |

## Power Supply Considerations

Place a 1- $\mu$ F low-ESR decoupling capacitor as close as possible to the  $V_{DD}$  pin.

**Figure 34:**  
Typical Application Hardware Circuit



$V_{BUS}$  in the above figures refers to the I<sup>2</sup>C bus voltage which is either  $V_{DD}$  or 1.8V. Be sure to apply the specified I<sup>2</sup>C bus voltage shown in the [Ordering & Contact Information](#) for the specific device being used.

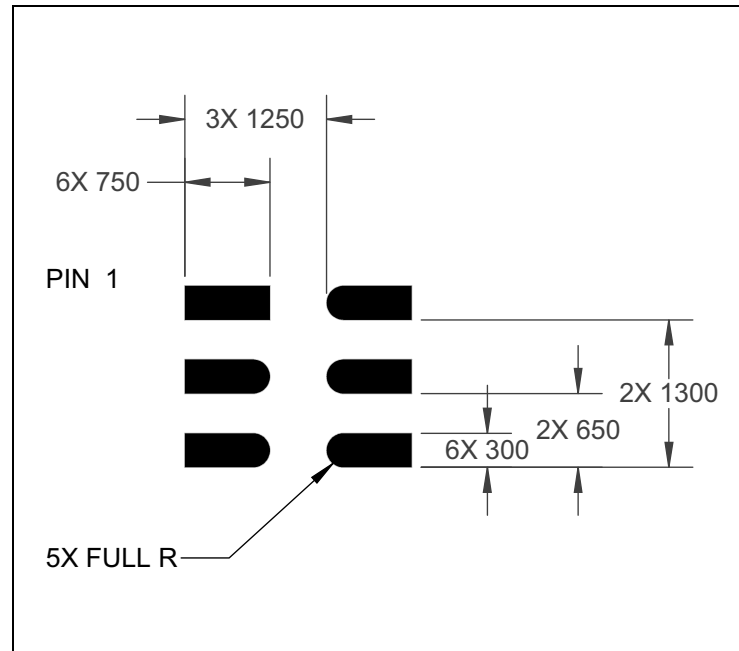
The I<sup>2</sup>C signals and the Interrupt are open-drain outputs and require pull-up resistors. The pull-up resistor ( $R_P$ ) value is a function of the I<sup>2</sup>C bus speed, the I<sup>2</sup>C bus voltage, and the capacitive load. The ams OSRAM EVM running at 400 kbit/s, uses 1.5-k $\Omega$  resistors. A 10-k $\Omega$  pull-up resistor ( $R_{PI}$ ) can be used for the interrupt line.

## PCB Pad Layout

Suggested PCB pad layout guidelines for the surface mount module are shown. Flash Gold is recommended as a surface finish for the landing pads.

**Figure 35:**  
**Suggested PCB Layout**

**PCB Layout:** Suggested land pattern based on the IPC-7351B Generic Requirements for Surface Mount Design and Land Pattern Standard (2010) for the small outline no-lead (SON) package.

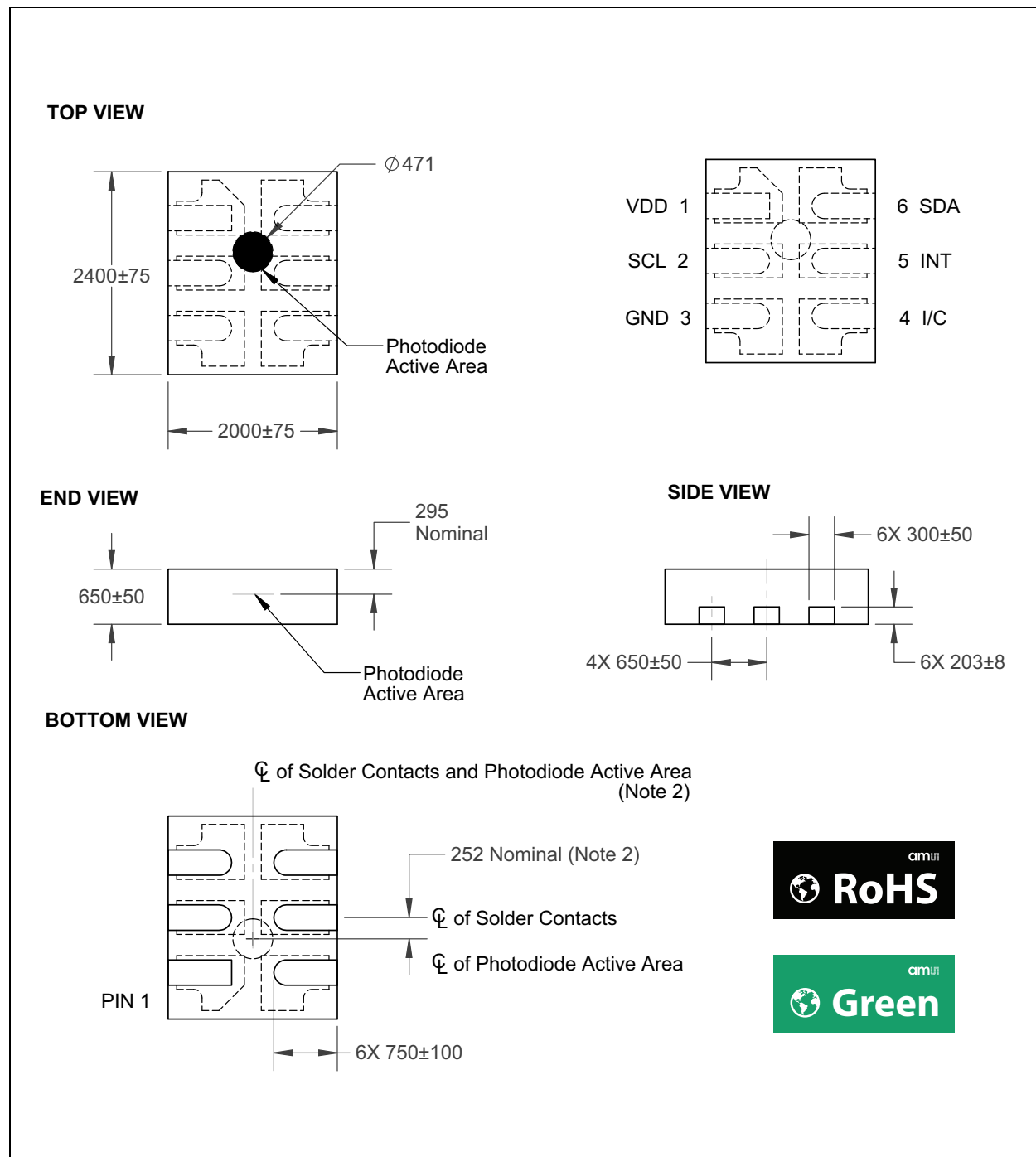


**Note(s):**

1. All linear dimensions are in millimeters.
2. This drawing is subject to change without notice.

## Package Drawings & Markings

**Figure 36:**  
IC Package Mechanical Drawing

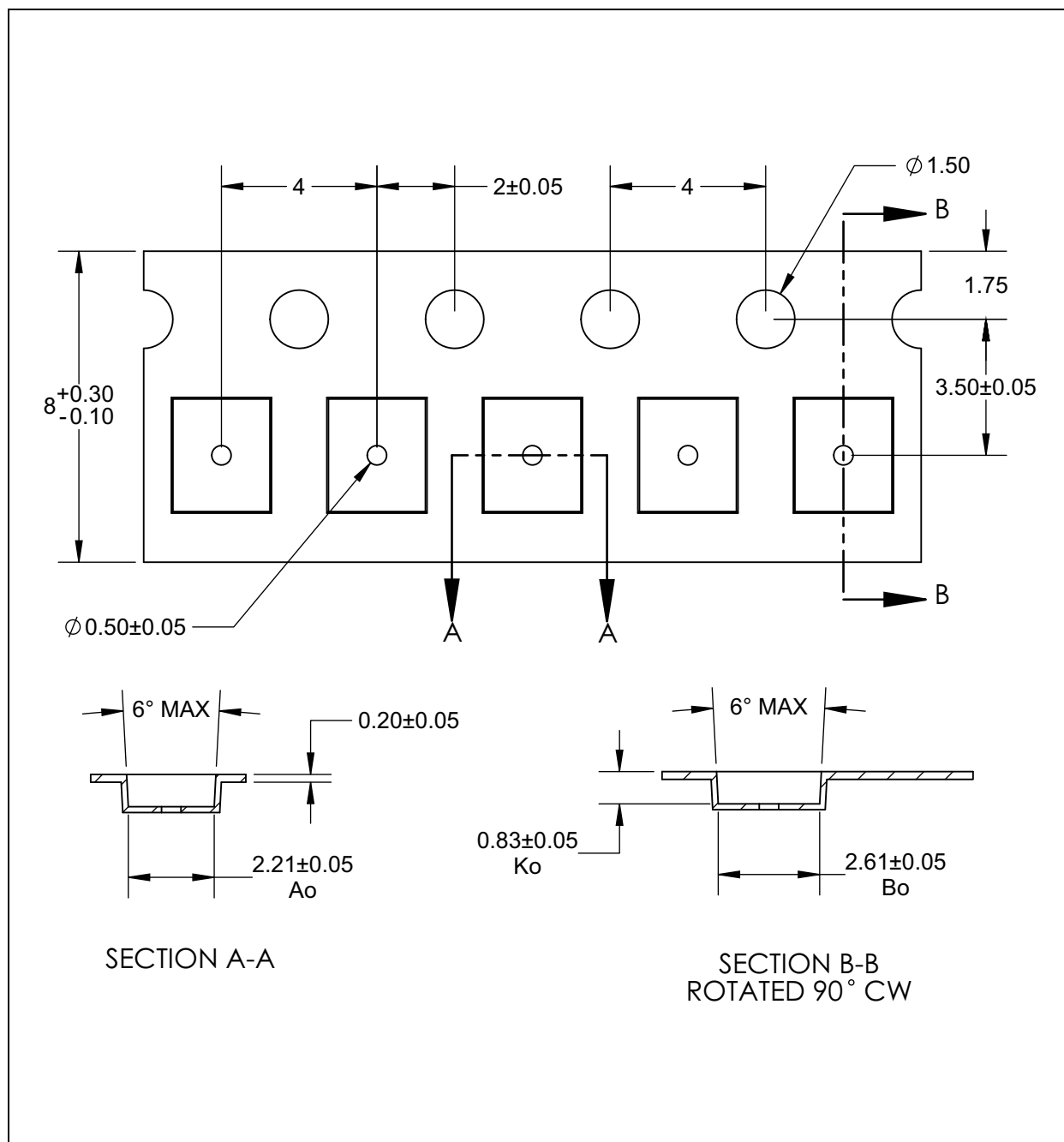


**Note(s):**

1. All linear dimensions are in micrometers. Dimension tolerance is  $\pm 20 \mu\text{m}$  unless otherwise noted.
2. The die is centered within the package within a tolerance of  $\pm 75 \mu\text{m}$ .
3. Package top surface is molded with an electrically non-conductive clear plastic compound having an index of refraction of 1.55.
4. Contact finish is Copper Alloy A194 with pre-plated NiPdAu lead finish.
5. This package contains no lead (Pb).
6. This drawing is subject to change without notice.

## Package Mechanical Data

**Figure 37:**  
Carrier Tape & Reel Information



**Note(s):**

1. All linear dimensions are in millimeters. Dimension tolerance is  $\pm 0.10$  mm unless otherwise noted.
2. The dimensions on this drawing are for illustrative purposes only. Dimensions of an actual carrier may vary slightly.
3. Symbols on drawing  $A_o$ ,  $B_o$ , and  $K_o$  are defined in ANSI EIA Standard 481-B 2001.
4. Each reel is 330 millimeters in diameter.
5. Packaging tape and reel conform to the requirements of EIA Standard 481-B.
6. In accordance with EIA standard, device pin 1 is located next to the sprocket holes in the tape.
7. This drawing is subject to change without notice.
8. The device pin 1 is located in the upper left corner inside the T&R pockets.

Soldering & Storage  
Information

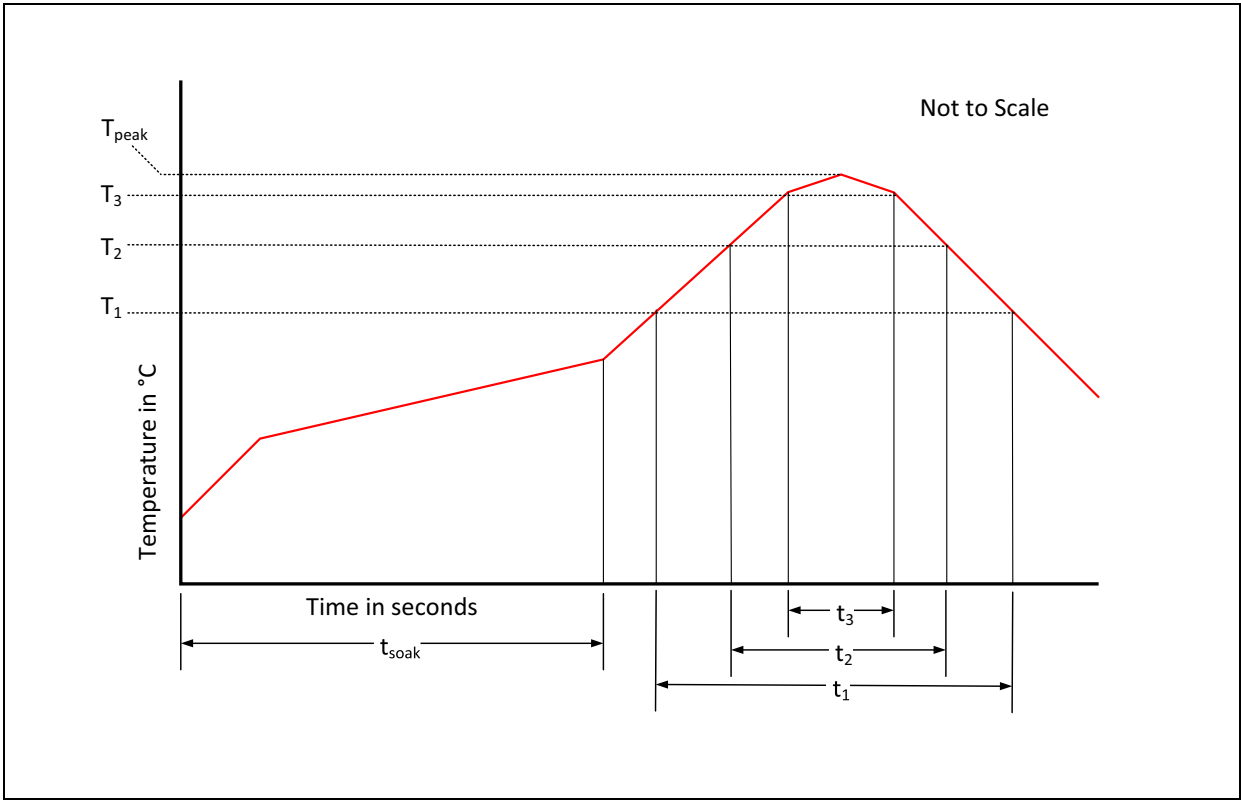
The FN package has been tested and has demonstrated an ability to be reflow soldered to a PCB substrate.

The solder reflow profile describes the expected maximum heat exposure of components during the solder reflow process of product on a PCB. Temperature is measured on top of component. The components should be limited to a maximum of three passes through this solder reflow profile.

Figure 38:  
Solder Reflow Profile

| Parameter                                                 | Reference         | Device         |
|-----------------------------------------------------------|-------------------|----------------|
| Average temperature gradient in preheating                |                   | 2.5°C/s        |
| Soak time                                                 | $t_{\text{soak}}$ | 2 to 3 minutes |
| Time above 217°C ( $T_1$ )                                | $t_1$             | Max 60 s       |
| Time above 230°C ( $T_2$ )                                | $t_2$             | Max 50 s       |
| Time above $T_{\text{peak}} - 10^\circ\text{C}$ ( $T_3$ ) | $t_3$             | Max 10 s       |
| Peak temperature in reflow                                | $T_{\text{peak}}$ | 260°C          |
| Temperature gradient in cooling                           |                   | Max -5°C/s     |

Figure 39:  
Solder Reflow Profile Graph



## Moisture Sensitivity

Optical characteristics of the device can be adversely affected during the soldering process by the release and vaporization of moisture that has been previously absorbed into the package. To ensure the package contains the smallest amount of absorbed moisture possible, each device is baked prior to being dry packed for shipping.

Devices are dry packed in a sealed aluminized envelope called a moisture-barrier bag with silica gel to protect them from ambient moisture during shipping, handling, and storage before use.

## Shelf Life

The calculated shelf life of the device in an unopened moisture barrier bag is 24 months from the date code on the bag when stored under the following conditions:

- Shelf Life: 24 months
- Ambient Temperature: < 40°C
- Relative Humidity: < 90%

Rebaking of the devices will be required if the devices exceed the 24 months shelf life or the Humidity Indicator Card shows that the devices were exposed to conditions beyond the allowable moisture region.

## Floor Life

The FN package has been assigned a moisture sensitivity level of MSL 3. As a result, the floor life of devices removed from the moisture barrier bag is 168 hours from the time the bag was opened, provided that the devices are stored under the following conditions:

- Floor Life: 168 hours
- Ambient Temperature: < 30°C
- Relative Humidity: < 60%

If the floor life or the temperature/humidity conditions have been exceeded, the devices must be rebaked prior to solder reflow or dry packing.

## Rebaking Instructions

When the shelf life or floor life limits have been exceeded, rebake at 50°C for 12 hours.

## Ordering & Contact Information

The device is packaged in a small OFN (Optical FN) package which is 2mm x 2.4mm.

**Figure 40:**  
Ordering Information

| Ordering Code              | Address | Interface                                                     | Delivery Form | Delivery Quantity |
|----------------------------|---------|---------------------------------------------------------------|---------------|-------------------|
| TCS34001FN                 | 0x39    | I <sup>2</sup> C V <sub>BUS</sub> = V <sub>DD</sub> Interface | FN-6          | 12000 pcs/reel    |
| TCS34001FNM                | 0x39    | I <sup>2</sup> C V <sub>BUS</sub> = V <sub>DD</sub> Interface | FN-6          | 500 pcs/reel      |
| TCS34003FN                 | 0x39    | I <sup>2</sup> C bus = 1.8V Interface                         | FN-6          | 12000 pcs/reel    |
| TCS34003FNM                | 0x39    | I <sup>2</sup> C bus = 1.8V Interface                         | FN-6          | 500 pcs/reel      |
| TCS34005FN <sup>(1)</sup>  | 0x29    | I <sup>2</sup> C V <sub>BUS</sub> = V <sub>DD</sub> Interface | FN-6          | 12000 pcs/reel    |
| TCS34005FNM <sup>(1)</sup> | 0x29    | I <sup>2</sup> C V <sub>BUS</sub> = V <sub>DD</sub> Interface | FN-6          | 500 pcs/reel      |
| TCS34007FN                 | 0x29    | I <sup>2</sup> C bus = 1.8V Interface                         | FN-6          | 12000 pcs/reel    |
| TCS34007FNM                | 0x29    | I <sup>2</sup> C bus = 1.8V Interface                         | FN-6          | 500 pcs/reel      |

**Note(s):**

1. Contact ams OSRAM for availability.

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| Document Status          | Product Status  | Definition                                                                                                                                                                                                                                                               |
|--------------------------|-----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Product Preview          | Pre-Development | Information in this datasheet is based on product ideas in the planning phase of development. All specifications are design goals without any warranty and are subject to change without notice                                                                          |
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## Revision Information

| Changes from 1-06 (2017-Oct-10) to current revision 2-00 (2023-Feb-09) | Page |
|------------------------------------------------------------------------|------|
| Updated Shelf Life from "12 months to 24 months"                       | 28   |

**Note(s):**

1. Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.
2. Correction of typographical errors is not explicitly mentioned.

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